

HIGH AND LOW SIDE DRIVER

Features

- · Floating channel designed for bootstrap operation
- Fully operational to +600V
- Tolerant to negative transient voltage dV/dt immune
- Gate drive supply range from 10 to 20V
- · Undervoltage lockout for both channels
- 3.3V logic compatible
 Separate logic supply range from 3.3V to 20V
 Logic and power ground ±5V offset
- · CMOS Schmitt-triggered inputs with pull-down
- · Cycle by cycle edge-triggered shutdown logic
- Matched propagation delay for both channels
- · Outputs in phase with inputs

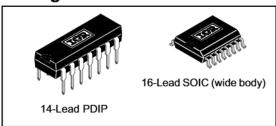
Description

The IR2112(S) is a high voltage, high speed power MOSFET and IGBT driver with independent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable rugge-dized monolithic construction. Logic inputs are com-

Product Summary

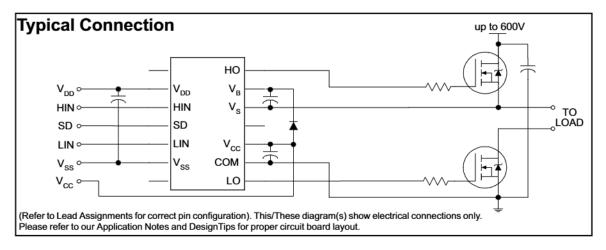
Voffset	600V max.
I _O +/-	200 mA / 420 mA
Vout	10 - 20V
t _{on/off} (typ.)	125 & 105 ns
Delay Matching	30 ns

Packages



patible with standard CMOS or LSTTL outputs, down to 3.3V logic.

The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify use in high frequency applications. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 600 volts.



Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions. Additional information is shown in Figures 28 through 35.

Symbol	Definition	Min.	Max.	Units	
V _B	High Side Floating Supply Voltage	-0.3	625		
VS	High Side Floating Supply Offset Voltage	V _B - 25	V _B + 0.3		
V _{HO}	High Side Floating Output Voltage		V _S - 0.3	V _B + 0.3	
V _{CC}	Low Side Fixed Supply Voltage		-0.3	25	v
V _{LO}	Low Side Output Voltage		-0.3	V _{CC} + 0.3	
V _{DD}	Logic Supply Voltage		-0.3	V _{SS} + 25	
V _{SS}	Logic Supply Offset Voltage	V _{CC} - 25	V _{CC} + 0.3		
V _{IN}	Logic Input Voltage (HIN, LIN & SD)	V _{SS} - 0.3	V _{DD} + 0.3		
dV _s /dt	Allowable Offset Supply Voltage Transient (Figure 2)		_	50	V/ns
PD	Package Power Dissipation @ T _A ≤ +25°C	(14 Lead DIP)	_	1.6	w
		(16 Lead SOIC)		1.25	_ vv
R _{THJA}	Thermal Resistance, Junction to Ambient	nal Resistance, Junction to Ambient (14 Lead DIP)		75	9C/M
	(16 Lead SOIC)		_	100	°C/W
TJ	Junction Temperature	_	150		
TS	Storage Temperature	-55	150	°C	
TL	Lead Temperature (Soldering, 10 seconds)	_	300		

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. The VS and VSS offset ratings are tested with all supplies biased at 15V differential. Typical ratings at other bias conditions are shown in Figures 36 and 37.

Symbol	Definition	Min.	Max.	Units
V _B	High Side Floating Supply Absolute Voltage	V _S + 10	V _S + 20	
VS	High Side Floating Supply Offset Voltage	Note 1	600	
V _{HO}	High Side Floating Output Voltage	VS	V _B	
V _{CC}	Low Side Fixed Supply Voltage	10	20	
V_{LO}	Low Side Output Voltage	0	Vcc	V
V_{DD}	Logic Supply Voltage	V _{SS} + 3	V _{SS} + 20	
V _{SS}	Logic Supply Offset Voltage	-5 (Note 2)	5	
V _{IN}	Logic Input Voltage (HIN, LIN & SD)	V _{SS}	V _{DD}	
T _A	Ambient Temperature	-40	125	°C

Note 1: Logic operational for V_S of -5 to +600V. Logic state held for V_S of -5V to -V_{BS}. (Please refer to the Design Tip DT97-3 for more details).

Note 2: When VDD < 5V, the minimum Vss offset is limited to -VDD.

Dynamic Electrical Characteristics

 V_{BIAS} (V_{CC}, V_{BS}, V_{DD}) = 15V, C_L = 1000 pF, T_A = 25°C and V_{SS} = COM unless otherwise specified. The dynamic electrical characteristics are measured using the test circuit shown in Figure 3.

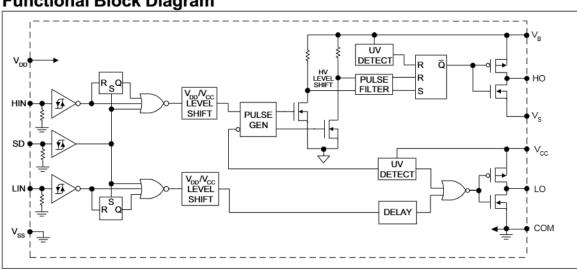
Symbol	Definition	Figure	Min.	Тур.	Max.	Units	Test Conditions
t _{on}	Turn-On Propagation Delay	7	_	125	180		V _S = 0V
t _{off}	Turn-Off Propagation Delay	8	_	105	160	ns	V _S = 600V
t _{sd}	Shutdown Propagation Delay	9	_	105	160		V _S = 600V
t _r	Turn-On Rise Time	10	_	80	130		
t _f	Turn-Off Fall Time	11	_	40	65		
MT	Delay Matching, HS & LS Turn-On/Off	_	_	_	30		

Static Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS} , V_{DD}) = 15V, T_A = 25°C and V_{SS} = COM unless otherwise specified. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to V_{SS} and are applicable to all three logic input leads: HIN, LIN and SD. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Definition	Figure	Min.	Тур.	Max.	Units	Test Conditions
V _{IH}	Logic "1" Input Voltage	12	9.5	_	_	v	
V _{IL}	Logic "0" Input Voltage	13	_	_	6.0	\ \	
V _{OH}	High Level Output Voltage, VBIAS - VO	14	_	_	100	\/	I _O = 0A
V _{OL}	Low Level Output Voltage, VO	15	_	_	100	mV	I _O = 0A
I _{LK}	Offset Supply Leakage Current	16	_	_	50		V _B = V _S = 600V
I _{QBS}	Quiescent V _{BS} Supply Current	17	_	25	60		V _{IN} = 0V or V _{DD}
IQCC	Quiescent V _{CC} Supply Current	18	_	80	180		V _{IN} = 0V or V _{DD}
I _{QDD}	Quiescent V _{DD} Supply Current	19	_	2.0	5.0	μA	V _{IN} = 0V or V _{DD}
I _{IN+}	Logic "1" Input Bias Current	20	_	20	40		V _{IN} = V _{DD}
I _{IN-}	Logic "0" Input Bias Current	21	_	_	1.0		V _{IN} = 0V
V _{BSUV+}	V _{BS} Supply Undervoltage Positive Going Threshold	22	7.4	8.5	9.6		
V _{BSUV} -	V _{BS} Supply Undervoltage Negative Going Threshold	23	7.0	8.1	9.2	v	
V _{CCUV+}	V _{CC} Supply Undervoltage Positive Going Threshold	24	7.6	8.6	9.6		
V _{CCUV} -	V _{CC} Supply Undervoltage Negative Going Threshold	25	7.2	8.2	9.2		
I _{O+}	Output High Short Circuit Pulsed Current	26	200	250	_	mA	V _O = 0V, V _{IN} = V _{DD} PW ≤ 10 μs
I _{O-}	Output Low Short Circuit Pulsed Current	27	420	500	_		V _O = 15V, V _{IN} = 0V PW ≤ 10 μs

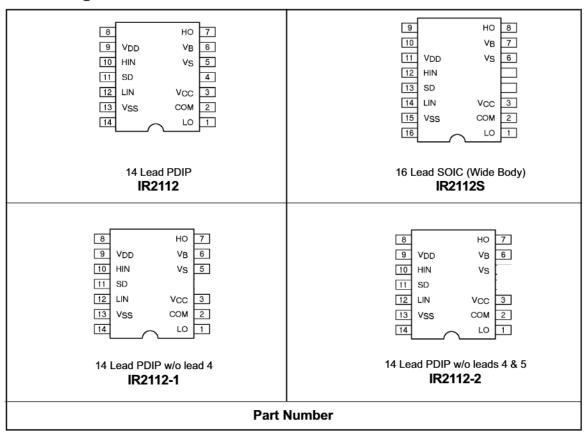




Lead Definitions

Symbol	Description		
V_{DD}	Logic supply		
HIN	Logic input for high side gate driver output (HO), in phase		
SD	Logic input for shutdown		
LIN	Logic input for low side gate driver output (LO), in phase		
Vss	Logic ground		
V _B	High side floating supply		
НО	High side gate drive output		
VS	High side floating supply return		
Vcc	Low side supply		
LO	Low side gate drive output		
СОМ	Low side return		

Lead Assignments



International **IOR** Rectifier

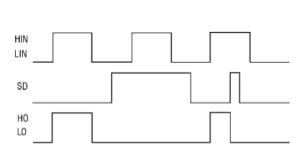


Figure 1. Input/Output Timing Diagram

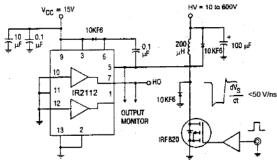


Figure 2. Floating Supply Voltage Transient Test Circuit

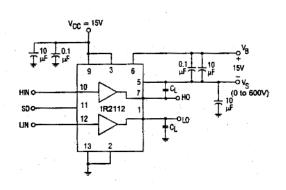


Figure 3. Switching Time Test Circuit

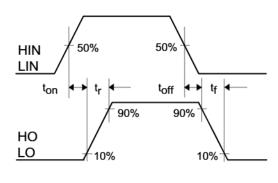


Figure 4. Switching Time Waveform Definition

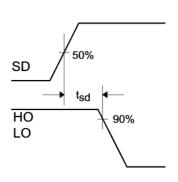


Figure 5. Shutdown Waveform Definitions

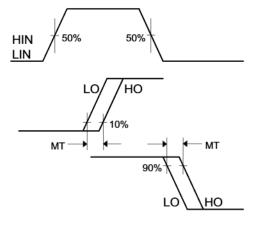
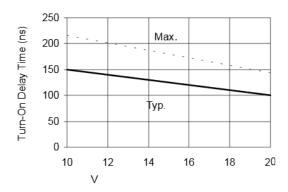


Figure 6. Delay Matching Waveform Definitions

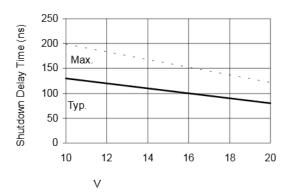
International

TOR Rectifier

IR2112(-1-2)(S)PbF

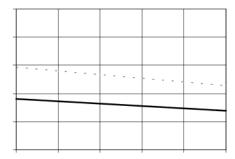


International **IOR** Rectifier



International TOR Rectifier

IR2112(-1-2)(S)PbF



International **IOR** Rectifier

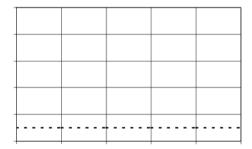


Figure 14B. High Level Output vs. Voltage

International **IOR** Rectifier

IR2112(-1-2)(S)PbF

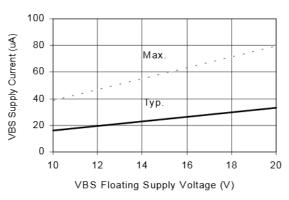


Figure 17B. VBs Supply Current vs. Voltage

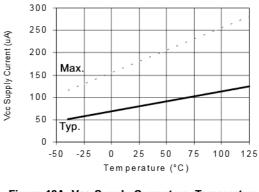


Figure 18A. Vcc Supply Current vs. Temperature

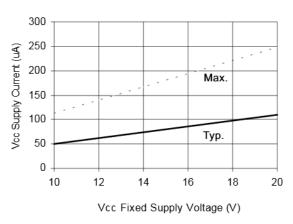


Figure 18B. V_{CC} Supply Current vs. Voltage

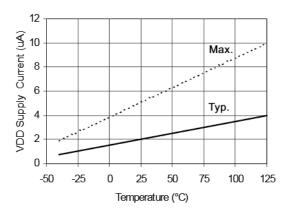


Figure 19A. V_{DD} Supply Current vs. Temperature

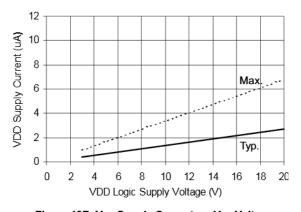


Figure 19B. V_{DD} Supply Current vs. V_{DD} Voltage

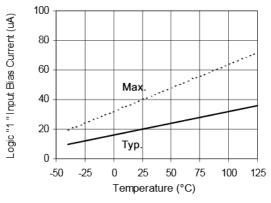


Figure 20A. Logic "I" Input Current vs. Temperature

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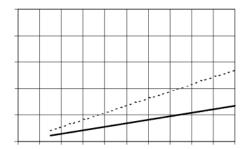


Figure 20B. Logic "1" Input Current vs. V_{DD} Voltage

International **TOR** Rectifier

IR2112(-1-2)(S)PbF

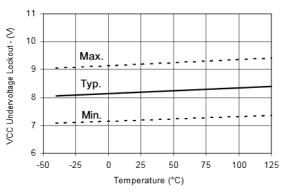


Figure 25. Vcc Undervoltage (-) vs. Temperature

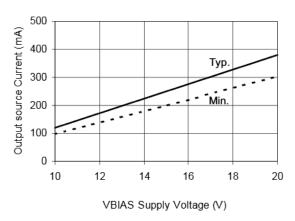


Figure 26B. Output Source Current vs. Voltage

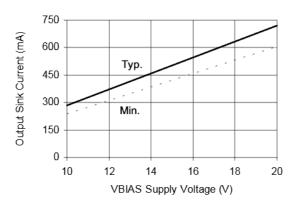


Figure 27B. Output Sink Current vs. Voltage

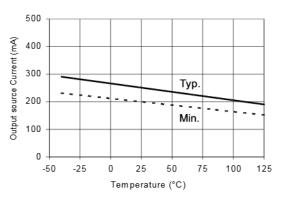


Figure 26A. Output Source Current vs. Temperature

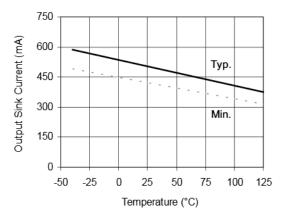


Figure 27A. Output Sink Current vs. Temperature

International **IOR** Rectifier

IR2112(-1-2)(S)PbF

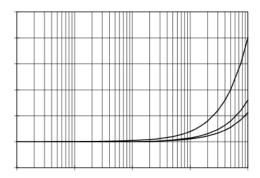


Figure 28. IR2112 TJ vs. Frequency (IRFBC20) $R_{GATE} = 33\Omega,\, V_{CC} = 15V$

Figure 29. IR2112 TJ vs. Frequency (IRFBC30) RGATE = 22 Ω , Vcc = 15V

International **TOR** Rectifier

IR2112(-1-2)(S)PbF

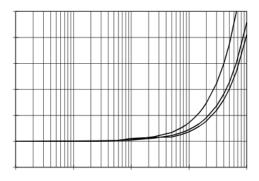
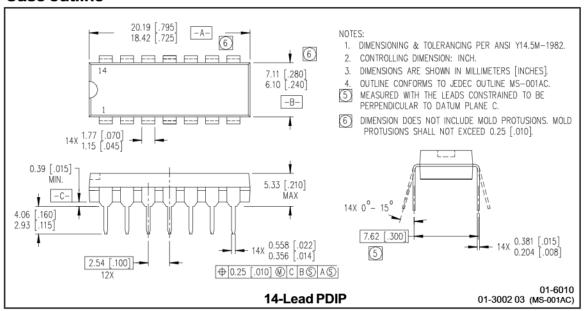
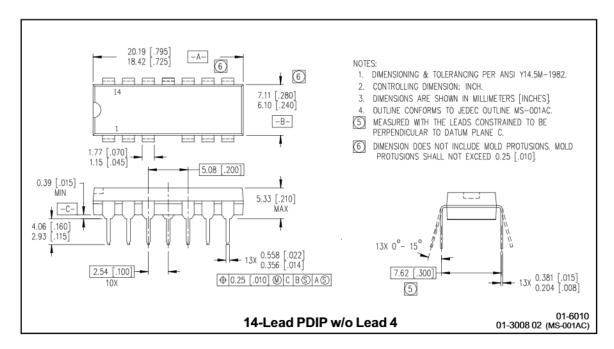


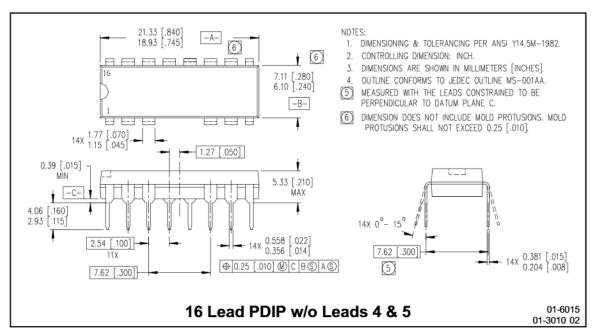
Figure 34. IR2112S T_J vs. Frequency (IRFBC40) $R_{GATE} = 15\Omega$, Vcc = 15V

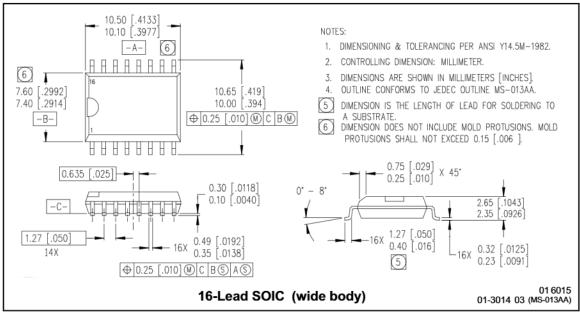
Figure 35. IR2112S T_J vs. Frequency (IRFPE50) R_{GATE} = 10 Ω , V_{CC} = 15V

Case outline

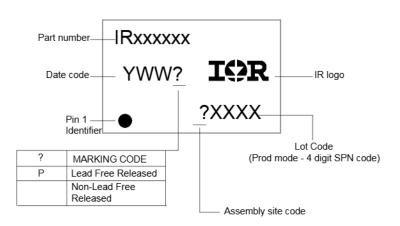








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International

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This product has been qualified per industrial level

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